|  |  |  |                  | 4   |            |   |  |  |   |                               |                            |                          |  |
|--|--|--|------------------|---|------------|---|--|--|---|-------------------------------|----------------------------|--------------------------|--|
|  |  |  |                  |   |            | Recommended configura                               | ation of plated throu                                    | gh holes for pres                              | s-in termination                          |                               |                            |                          |  |
| RTING POWER CO   | nnector for A  | dvancedTCA@                                | ) female         |   | RoHS, cFLu |   |  | -  | ÷   | : :                           | <u>.</u>                   |                          |  |
|  |  |  | ,                |   |            | according to Telcordia                              | Bellcore GR 1217COR                                      | E Part7. It is appr                            | oved to be used                           | Drill                         |                            |                          | Power contacts<br>1,75 ± 0,025 mr                        |
|  | :  |  | ÷                |   |            | with a plated through<br>Ø 1,00 +0.09/-0.06 mm      | for signal contacts                                      | (drilled hole Ø1,1                             | 5 ±0.025 mm) and                          | Tin<br>plated PCB (HAL)       |                            | 5 – 15 µm                | 5 – 15 µm  |
| eral information   | <u>-</u>   |  |                  |   |            | <b>Ø</b> 1,60 +0.09/-0.06 mm                        | for power contacts                                       | (drilled hole Ø1,7                             | '5 ±0.025 mm).                            | finis                         |                            |                          | 1,60 - 1,70 mm   |
|  |  |  |                  |   |            | Based on our experience<br>manufacturer we recom    | ces regarding the pro                                    | duction process of                             | of the PCB                                | Chemical tin                  |                            | + 0,025 mm<br>8 - 1,5 µm | 1,75 ± 0,025 mi<br>0,8 - 1,5 µm                          |
| ign<br>of contacts   | PICMG® 3.0 R2.0<br>Power contacts  | 8  | Signal contacts  | 22, max. 26                                     |            | <ul> <li>in the table. To achieve</li> </ul>        | e the recommended r                                      | lated through hole                             | e diameter it is                          | plated PCB finis              |                            |                          | 1,60 - 1,70 mr   |
| st voltage   | Contacts 1–16  | 1000 V г.m.s.                              | Contacts 17-34   | 2000 V r.m.s.                                   |            | important to specify es<br>resp. Ø 1,75 ±0.025 mm   | specially the drilled i<br>n to your PCB supplie         | nole diameter ot s<br>er.                      | <b>ρ</b> 1,15 ±0.025 mm                   |                               |                            |                          | 1,75 ± 0,025 m   |
| ntact resistance   | Power contacts   | <u>&lt;</u> 2,2 mOhm                       | Signal contacts  | <u>&lt;</u> 8,5 mOhm                            |            | -   | drilled hole Ø   |  |   | Gold /Nickel<br>plated PCB    |                            | 3 – 7 µm<br>5 – 0,12 µm  | 3 – 7 μm<br>0,05 – 0,12 μ                                |
| rking current<br>Jlation resistance  | Power contacts<br><u>&gt;</u> 10 <sup>10</sup> Ohm   | 16 A @ 70°C                                | Signal contacts  | 1 A @ 70°C                                      |            | -   | -  | <br>   | 25µm                                      |                               |                            |                          | <u>1,60 – 1,70 п</u>                                     |
| nperature range  |  |  |                  |   |            | -   |  |  |   |                               | lled hole Ø 1,15           | + 0,025 mm               | 1,75 ± 0,025 i   |
| mination technology  | press-in   |  |                  |   |            |   |  |  |   | plated PCB                    |                            | 1 - 0,3 µm               | 0,1 - 0,3 µr   |
|  | Contacts   | 5-16                                       | 0,7 mm           |   |            | _   |  |  |   |                               |                            |                          | 1,60 — 1,70 п<br>1,75 ± 0,025                            |
|  | <u>Contacts</u><br>Contacts  | 17-24<br>25-26                             | 2,5 mm<br>5,5 mm |   |            | -   |  |  |   |                               |                            |                          | 1,60 - 1,70 r  |
| arance & creepage distance   | Contacts   | 27-34                                      | 1,4 mm           |   |            | -   | finished hole $\emptyset$                                |  |   | All surfaces Pa               | ad size Ø mi               | in. 1,4 mm               | min. 2,0 mr  |
|  | Contacts   | 13-16 to 17-20                             | 3,0 mm           |   |            | _   | plating (e.g. Sn)  | ╼┥   |   |                               |                            |                          |  |
|  | <u>Contacts</u><br>Contacts  | 21-24 to 25-26<br>25-26 to 27-29           | 1,0 mm<br>2,0 mm |   |            | -   | praring (e.g. SII)                                       | ╼╫╼  |   |                               |                            |                          |  |
|  | 1st:   | 25, 26, 28, 29, 30, 31                     | 3rd:             | 5-24, 34  |            | -   |  |  |   |                               |                            |                          |  |
| uentioal contact engagement  | 2nd:   | 33   | 4th:             | 27, 32  |            | _   |  |  |   |                               |                            |                          |  |
| rtion & withdrawal force   | < 67 N<br>250  |  |                  |   |            | -   |  |  |   |                               |                            |                          |  |
| ing cycles<br>file   | E102079  | ,  |                  |   |            | -   |  |  |   |                               |                            |                          |  |
| S – compliant  | Yes  |  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| dfree  | Yes  |  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| erial  |  | , glass fiber reinforcement)               |                  |   |            | -<br>-<br>-<br>-                                    |  |  |   |                               |                            |                          |  |
| iterial<br>lor<br>classification   | grey<br>UL 94-V0   | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| rerial<br>or<br>classification   | grey   | -  |                  |   |            | -<br>-<br>-<br>-<br>-                               |  |  |   |                               |                            |                          |  |
| terial<br>or<br>classification<br>terial group acc. IEC 60664-1  | grey<br>UL 94-V0   | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| terial<br>or<br>classification<br>terial group acc. IEC 60664-1<br>ntact material  | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400  | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| terial<br>or<br>classification<br>terial group acc. IEC 60664-1<br><b>stact material</b><br>itact material<br>ting termination zone  | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni                        | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| terial<br>or<br>classification<br>terial group acc. IEC 60664-1<br><b>stact material</b><br>itact material<br>ting termination zone  | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400  | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| rerial<br>or<br>classification<br>rerial group acc. IEC 60664-1<br>tact material<br>tact material<br>ting termination zone<br>ting contact zone  | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 µm) over Ni | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| terial<br>lor<br>classification<br>terial group acc. IEC 60664-1<br>ntact material<br>ating termination zone<br>ating contact zone<br>rating diagram acc. to IEC 60512-5 (Curren   | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni |  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| terial<br>lor<br>classification<br>terial group acc. IEC 60664-1<br>ntact material<br>ntact material<br>ating termination zone<br>ating contact zone<br>rating diagram acc. to IEC 60512-5 (Curren<br>ominal derating, all contacts under load acc. to   | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni | -  |                  |   |            |   |  |  |   |                               |                            |                          |  |
| Iterial<br>lor<br>classification<br>Iterial group acc. IEC 60664-1<br><b>ntact material</b><br>ntact material<br>ating termination zone<br>ating contact zone<br>rating diagram acc. to IEC 60512-5 (Curren<br>nominal derating, all contacts under load acc. to                                     | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni | 40<br>35<br>30<br>2                        |                  |   |            | Origina   | al Size DIN A3   | Scale Free siz                                 |   | Standardisation               | Ref.<br>Sub.               | 5+2+0                    |  |
| Iterial<br>lor<br>classification<br>Iterial group acc. IEC 60664-1<br><b>ntact material</b><br>ntact material<br>ating termination zone<br>ating contact zone<br>rating diagram acc. to IEC 60512-5 (Curren<br>nominal derating, all contacts under load acc. to                                     | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni | 40<br>35<br>1<br>30<br>2<br>25<br>40<br>25 |                  |   |            | Origin.   | al Size DIN A3   | l:1<br>eated by<br>PESCUD                      | Inspected by<br>PRIESTER                  | Standardisation<br>HOFFMANN   | Sub.<br>Date<br>2018-06-05 | State<br>Final Re        |  |
| terial<br>lor<br>classification<br>terial group acc. IEC 60664-1<br>ntact material<br>ntact material<br>ating termination zone<br>ating contact zone<br>rating diagram acc. to IEC 60512-5 (Curren<br>ominal derating, all contacts under load acc. to   | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni | 40<br>35<br>1<br>30<br>2<br>25<br>40<br>25 |                  | 50 60 70<br>Ambient temperature [C <sup>4</sup> |            | All right<br>Department E<br>HARTING Electronics Gm | al Size DIN A3<br>TS reserved PO<br>CC PD - DE Tit<br>hH | eated by<br>PESCUD<br><sup>le</sup> Power coni | Inspected by<br>PRIESTER<br>nector for Ad | HOFFMANN<br>vancedTCA, female | Sub.<br>Date<br>2018-06-05 | Final Re                 | Doc-Key / ECM<br>100790527/UGD/0<br>500000135670<br>Rev. |
| sulator material<br>aterial<br>lor<br>. classification<br>aterial group acc. IEC 60664-1<br>ontact material<br>ating termination zone<br>ating contact zone<br>erating diagram acc. to IEC 60512-5 (Curren<br>nominal derating, all contacts under load acc. to<br>derating curve at I*0,8 (IEC 512) | grey<br>UL 94-V0<br>IIIa (175 <u>&lt;</u> CTI < 400<br>Copper alloy<br>Ni<br>Au (0,8 μm) over Ni | 40<br>35<br>1<br>30<br>2<br>25<br>40<br>25 |                  |   |            | Origin.<br>All right<br>Department E                | al Size DIN A3<br>TS reserved PO<br>CC PD - DE Tit<br>hH | eated by<br>PESCUD<br><sup>Le</sup> Power coni | Inspected by<br>PRIESTER                  | HOFFMANN<br>vancedTCA, female | Sub.<br>Date<br>2018-06-05 | Final Re                 | Doc-Key / ECM<br>100790527/UGD/0<br>500000135670         |

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| у       | Standardisation  | Date       | State   |             |                   |   |
|         | HOFFMANN         | 2018-06-05 | Final R | nal Release |                   |   |
| r Ad    | vancedTCA, femal | 2          |         |             | CM-Nr.<br>1/001/A | F |
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